

HiTemp ET Series Thermoelectric Cooler

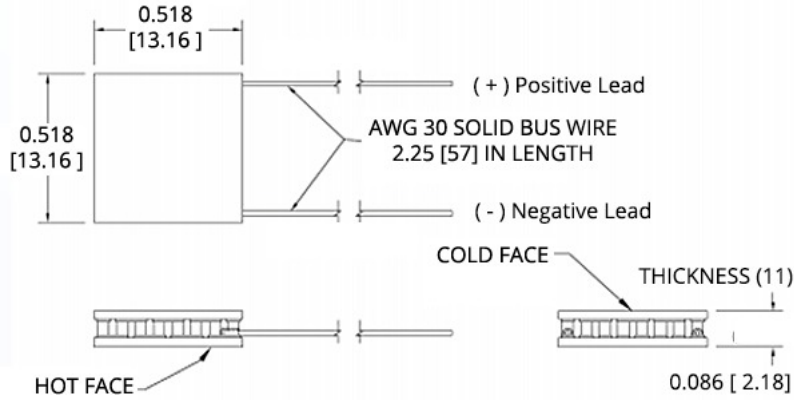
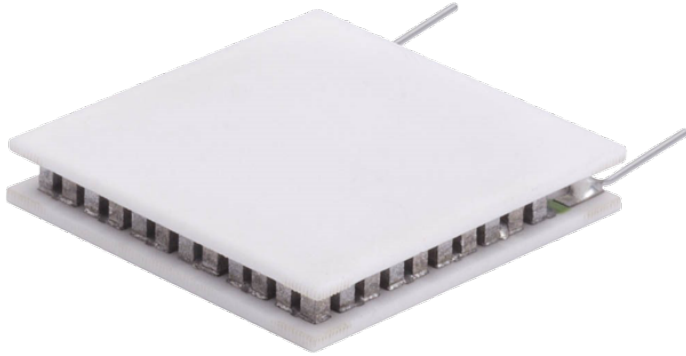
The ET20-68-F1A-1313-11-EP-W2.25 high temperature Thermoelectric Cooler uses Laird's enhanced Thermoelectric Module construction preventing performance degrading copper diffusion, which is common in standard grade TEMs operating in high temperature environments exceeding 80 °C. It has a maximum Qc of 9.5 Watts when ΔT = 0 and a maximum ΔT of 77.9 °C at Qc = 0.

Features

- High-temperature operation
- Reliable solid-state
- No sound or vibration
- Environmentally-friendly
- RoHS-compliant

Applications

- Peltier Cooling for Refrigerated Centrifuges
- Peltier Cooling for Machine Vision
- Thermoelectric Cooling for CMOS Sensors
- Cooling Solutions for Autonomous Systems
- Peltier Cooling for Digital
- Light Processors



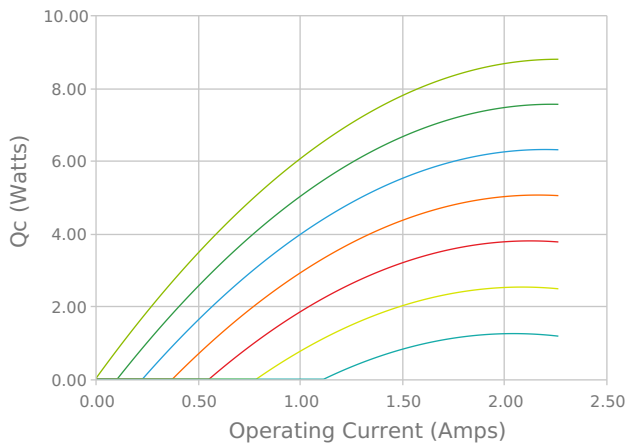
Ceramic Material: Alumina (Al₂O₃)
 Solder Construction: 232°C, SbSn

INCHES [MM]

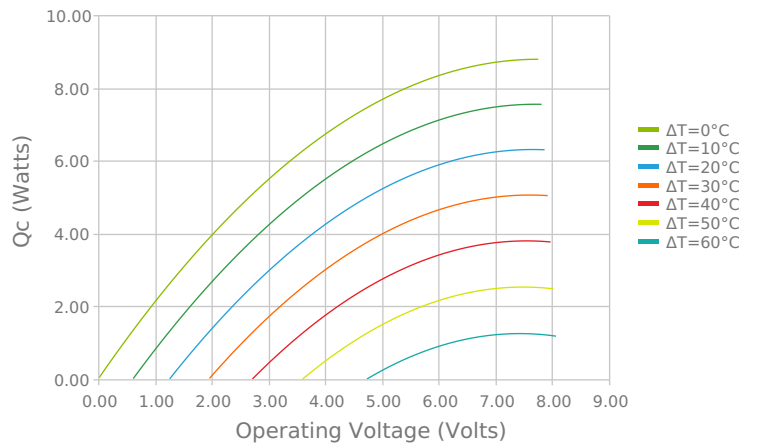
Note: Allow 0.020 in [0.5 mm] around perimeter of the thermoelectric cooler and lead wire attachment to accommodate sealant

ELECTRICAL AND THERMAL PERFORMANCE

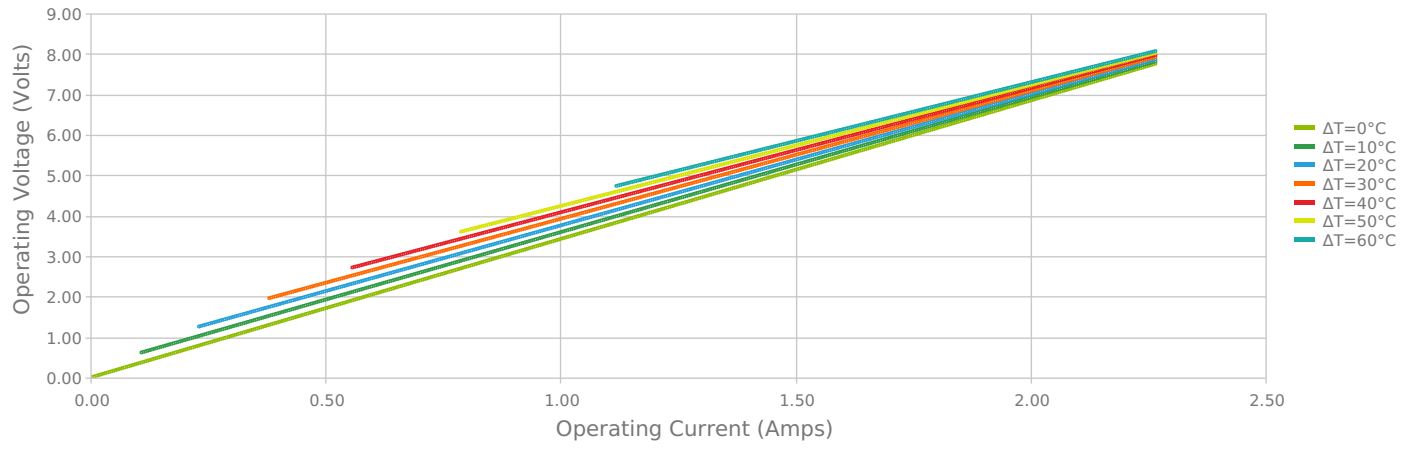
Heat Pumped at Cold Side
 T_{hot} = 85 °C



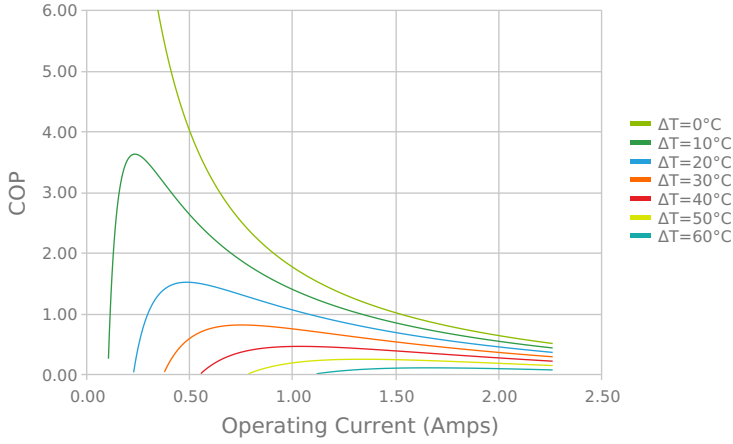
Heat Pumped at Cold Side
 T_{hot} = 85 °C



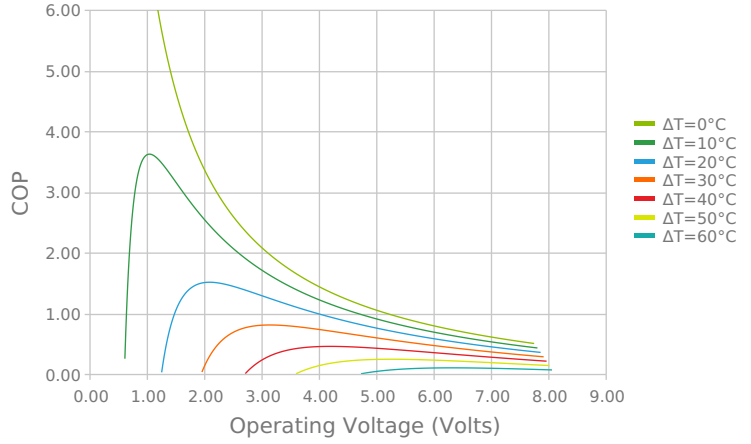
Current vs Voltage (I vs V)
Thot = 85 °C



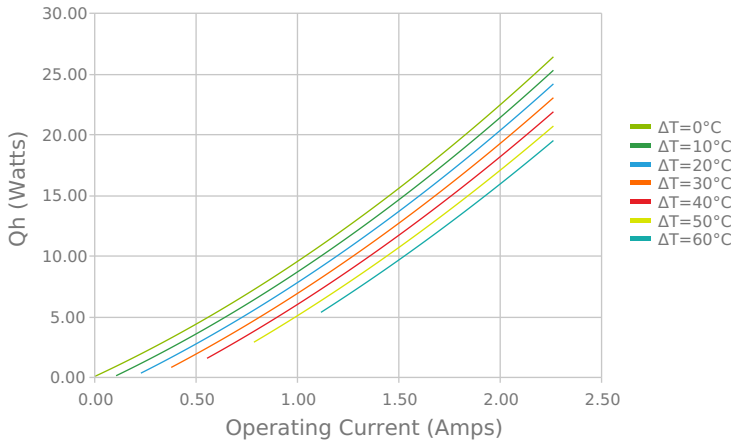
Coefficient of Performance (COP = Qc/Pin)
 Thot = 85 °C



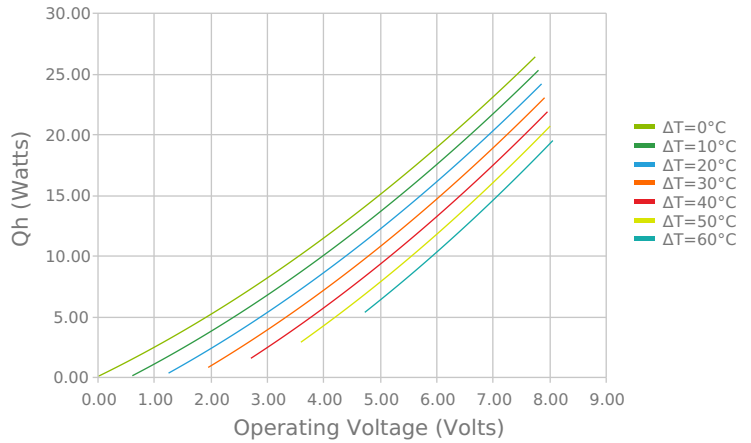
Coefficient of Performance (COP = Qc/Pin)
 Thot = 85 °C



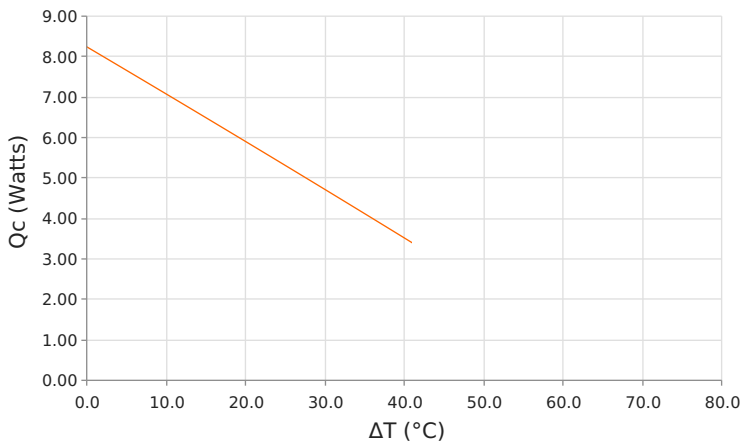
Total Heat Dissipated at Hot Side (Qh=Qc+Pin)
 Thot = 85 °C



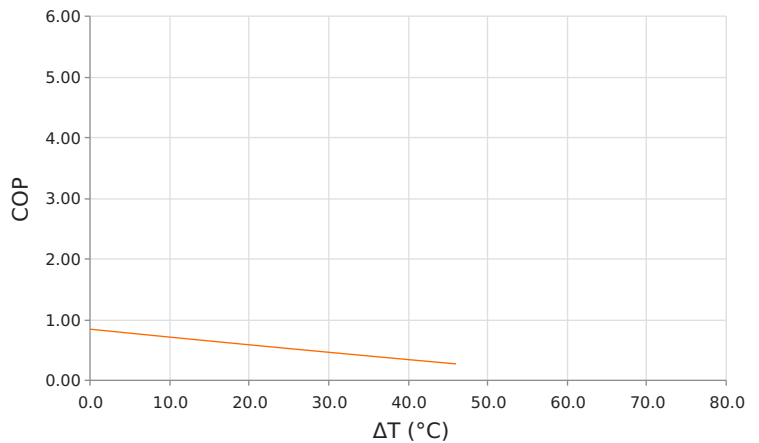
Total Heat Dissipated at Hot Side (Qh=Qc+Pin)
 Thot = 85 °C



Heat Pumped at Cold Side (Qc)
 Thot = 85 °C | Current = 1.7 Amps



Coefficient of Performance (COP = Qc/Pin)
 Thot = 85 °C | Current = 1.7 Amps



SPECIFICATIONS*

	50.0 °C	85.0 °C	110.0 °C
Hot Side Temperature			
Qcmax ($\Delta T = 0$)	9.5 Watts	10.4 Watts	10.9 Watts
ΔT_{max} ($Q_c = 0$)	77.9°C	89.3°C	96.2°C
I_{max} (I @ ΔT_{max})	2.0 Amps	1.9 Amps	1.9 Amps
V_{max} (V @ ΔT_{max})	8.2 Volts	9.4 Volts	10.2 Volts
Module Resistance	3.83 Ohms	4.45 Ohms	4.87 Ohms
Max Operating Temperature	150 °C		
Weight	2.0 gram(s)		

* Specifications reflect thermoelectric coefficients updated March 2020

FINISHING OPTIONS

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
11	2.184 ±0.051 mm 0.086 ± 0.002 in	0.051 mm / 0.051 mm 0.002 in / 0.002 in	Lapped	Lapped	50.8 mm 2.00 in

SEALING OPTIONS

Suffix	Sealant	Color	Temp Range	Description
EP	Epoxy	Black	-55 to 150°C	Low density syntactic foam epoxy encapsulant

NOTES

1. Max operating temperature: 150°C
2. Do not exceed I_{max} or V_{max} when operating module
3. Reference assembly guidelines for recommended installation

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Date: 04/24/2020